



Docket No. 11675.76.1.1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Sandhu et al.

Serial No.: 09/627,381

Filed: July 28, 2000

Confirmation No.: 2473

For: INTERLEVEL DIELECTRIC STRUCTURE AND
METHOD OF FORMING SAME

Examiner: T. Quach

CLEAN VERSION OF THE PENDING CLAIMS

Commissioner for Patents
Washington, D. C. 20231

Sir:

In response to the Notice of Non-Compliant Amendment under 37 C.F.R. § 1.121 mailed from the United States Patent and Trademark Office on February 25, 2003, below are a clean version of the claims currently pending in the above-identified case. Applicant's previous Amendment and Response, dated February 3, 2003, was filed according to the guidelines promulgated by the U.S. Patent and Trademark Office on January 31, 2003 at <<<http://www.uspto.gov/web/offices/pac/dapp/opla/preognotice/revamdtprac.htm>>>. Nevertheless,

this Clean Version of the Amended Claims is herewith submitted to further the prosecution of this case.